



PATENT

In re Application of: James M. Derderian

Serial No.: 10/770,890

Filed: February 2, 2004

**For: METHODS FOR FORMING
ASSEMBLIES AND PACKAGES THAT
INCLUDE STACKED SEMICONDUCTOR
DEVICES SEPARATED A DISTANCE
DEFINED BY ADHESIVE MATERIAL
INTERPOSED THEREBETWEEN**

Confirmation No.: 1094

Examiner: L. Thai

Group Art Unit: 2891

**Attorney Docket No.: 2269-4817.3US
(01-0103.03/US)**

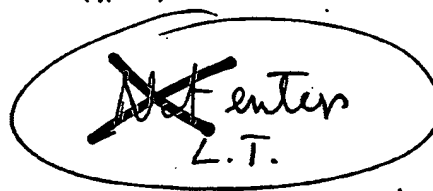
CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

January 2, 2007
Date

[Signature]
Signature

Erika Gandre
Name (Type/Print)



1/22/07

Entered w/RCE
2/1/07

AMENDMENT UNDER 37 C.F.R. §1.116

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Examiner:

This Amendment follows the final Office Action of November 1, 2006, the shortened statutory period for response to which expires on February 1, 2007. As January 1, 2007, and January 2, 2007, were federal holidays (New Year's Day and former President Gerald R. Ford's funeral, respectively), the two month period for filing an early response to the final Office Action expires on Wednesday, January 3, 2007. 37 C.F.R. § 1.7. This response is being submitted within two months from the mailing date of the final Office Action.

A listing of claims, in which amendments to the claims are set forth, starts at page 2 of this paper; and

Remarks begin on page 8 of this paper.